	PC SSOCIATION CONNECTING SECTRONICS INDUSTRIES®	© Copyright 2	al Compo 2005. IPC, Bannoo onal and Pan-Amer	kburn, Illinois	. All rights reserve	tion with lov		parts, the	declaratio	n encompas	sses all lowe		for which	ne item is an assembly the manufacturer has declaration.
IPC-1752-2 v1.02 IPC Web Site for Informati http://www.ipc.org/IPC-1			ation on IPC-1752 Standard -175x				rm Type *	I	Declaration Class *					
Sup	plier Information													
Company Name *		Comp	Company Unique ID		Unique ID Authority		Res	Response Date *		Res	Response Document ID			
Contact Name *		Title -	Contact	Phone - Co		hone - Contact *		Email - Contact *						
Authorized Representative *		ve * Title -	* Title - Representative		Phone - Representative *		Ema	Email - Representativ		* Sup	plier Comm	ents or URL for	Additional	nformation
	Requester Item Numbe	r Mfr Ite	m Number		Mfr Item Name		Effec	tive Date	Version	Manufactur	ing Site	Weight	UOM	Unit Type
	Alternate Recommend	ation							Alternate	Item Comm	ents			
Ма	nufacturing Proces	ss Informa	ation				·				·			
Terminal Plating / Grid Array Mate		Material	aterial Terminal E		ase Alloy	J-STD-020 MSL	Rating	ng Peak Process Boo		Temperatur	ature Max Time at Peak Tempera		ure Number	of Reflow Cycles
										С		second	ds	
Com	nments													

Save the fields this form to a file	·	Clear all of the fields on this form	Lock the fields on this form to prevent chan	
RoHS Materia	I Composition Declaration		Declaration Type	*
	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogene Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mas			rominated Biphenyls (PBB),
RoHS Declaration			Supplier Acceptance	
Exemptions: The exemptions for the	items on this form meet the specifications of the RoHS Definition above, excepitem.	t for the following application-specific exe	mptions. Check the appropriate	e boxes below for the applicable
1. Mercury in c	ompact fluorescent lamps not exceeding 5 mg per lamp	7c. Lead in electronic ceramic parts	(e.g. piezoelectronic devices)	
2a. Mercury in halophosphate	straight flourescent lamps for general purposes not exceeding 10 mg in lamps	Cadmium and its compounds in el banned under Directive 91/338/EEC marketing and use of certain danger	amending. Directive 76/769/EEC	
2b. Mercury in lamps with a new	straight flourescent lamps for general purposes not exceeding 5 mg in triphosphate ormal lifetime	9. Hexavalent chromium as an anti-correfrigerators	orrosion of the carbon steel coolin	ng system in absorption
2c. Mercury in lamps with long	straight flourescent lamps for general purposes not exceeding 8 mg in triphosphate lifetime	10a. DecaBDE in polymeric applicati	ons	
3. Mercury in s	raight flourescent lamps for special purposes	10b. Lead in lead-bronze bearing she	ells and bushes	
4. Mercury in o	her lamps not specifically mentioned in this list	11. Lead used in compliant pin conne	ctor systems	
5. Lead in glas	s of cathode ray tubes, electronic components and flourescent tubes	12. Lead as a coating material for a t	hermal conduction module c-ring	
6a. Lead as an	alloying element in steel containing up to 0.35% lead by weight	13a. Lead in optical and filter glass		
6b. Lead as an	alloying element in aluminum containing up to 0.4% lead by weight	13b. Cadmium in optical and filter gla	SS	
6c Lead as a	n alloying element in copper containing up to 4% lead by weight	14. Lead in solders consisting of mor the package of microprocessors with		
7a . Lead in hig weight or more	n melting temperature type solders (i.e. lead based solder alloys containing 85 % by lead)	15. Lead in solders to complete a via carrier within integrated circuit Flip Cl		semiconductor die and
	ders for servers, storage and storage array systems, network infrastructure switching, signalling, transmission as well as network management for tions			
Declaration S	ignature			
	complete all of the required fields on all pages of this form. Select the "Accident required by the Requester) and click on Submit Form to have the form return to have the have the form return to have the have the form return to have the		rop-down. This will display the	e signature area. Digitally sign
Supplier Digital S				

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +P Inserts a New Part +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem	Homogeneous Material	Waimb4	Unit of Measure	Level	Substance Category	Substance	CAS	Evenuet	Wajaht	Unit of Measure	Toler	ance	PPM
Name	Material	weignt	Measure	Level	Substance Category	Substance	CAS	Exempt	weight	Measure	-	+	FFIVI
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Homogeneous Material Composition Declaration for Electronic Products

Requester Instructions: The requester can optionally include additional substance categories and substances that must be declared for the item on this form. This is in addition to JIG Level A and JIG Level B substances already included for the JIG section. The requester should enter additional substance categories and then enter name of the substance and the CAS number. These entries will be accessible to the supplier via Level drop-down by selecting "Requester". Use the Load "Requester" and Test button to view the entries, just select "Requester" in the Level drop-down list in the previous section.

	Substance Category	Substance	CAS